## **PRODUCT / PROCESS CHANGE NOTIFICATION**

1. PCN basic data			
1.1 Company		STMicroelectronics International N.V	
1.2 PCN No.		MDG/19/10816	
1.3 Title of PCN		TSMC (Taiwan) additional source for STM32F4 & STM32F7 listed products in M10/90nm technology	
1.4 Product Category		STM32F72/3 & STM32F46/7 & STM32F76/7 products in M10/90nm technology	
1.5 Issue date		2019-02-10	

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	FRANK SCHIFANO	
2.1.2 Phone	+1 5148333778	
2.1.3 Email	frank.schifano@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Ricardo Antonio DE SA EARP	
2.1.2 Marketing Manager	Veronique BARLATIER	
2.1.3 Quality Manager	Pascal NARCHE	

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Wafer fabrication	TSMC Fab14 (Taiwan)

4. Description of change		
	Old	New
4.1 Description	Front-end source: - ST Crolles CR300 (France) - ST Crolles CR300 (France) - ST Crolles CR300 (France) - Existing so - TSMC Fab14 (Taiwan) - Additional source There is no change in the product function Please refer to PCN 10816 – Additional information attached document.	
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	no change	

5. Reason / motivation for change		
5.1 Motivation Due to the success on the market of STM32 devices, ST Microcontrollers Division deci qualify an additional front-end site to maintain state of the art service level to our custor thanks to extra capacity.		
5.2 Customer Benefit	CAPACITY INCREASE	

6. Marking of parts / traceability of change		
6.1 Description	Change is visible through diffusion traceability plant, in the marking: - "VQ" for ST Crolles CR300 (France) - "9R" for TSMC Fab14 (Taiwan) Please refer to PCN 10816 – Additional information attached document.	

7. Timing / schedule		
7.1 Date of qualification results	2019-10-01	
7.2 Intended start of delivery	2019-11-01	
7.3 Qualification sample available?	Not Applicable	

8. Qualification / Validation

8.1 Description	10816 MDG-MCD RER1715 - PCN10333 - PCN10544 - PCN10595 - PCN10703 - PCN10596 - PCN10671 - PCN 10816 TSMC Taiwan.pdf		
8.2 Qualification report and qualification results		Issue Date	2019-02-10

## 9. Attachments (additional documentations)

10816 Public product.pdf 10816 PCN10816\_Division Note M10 Additional Source.pdf 10816 MDG-MCD RER1715 - PCN10333 - PCN10544 - PCN10595 - PCN10703 - PCN10596 - PCN10671 - PCN 10816 TSMC Taiwan.pdf 10816 PCN10816\_Additional information.pdf

10. Affected parts			
10. 1 Current		10.2 New (if applicable)	
10.1.1 Customer Part No 10.1.2 Supplier Part No		10.1.2 Supplier Part No	
	STM32F767VGT6		

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